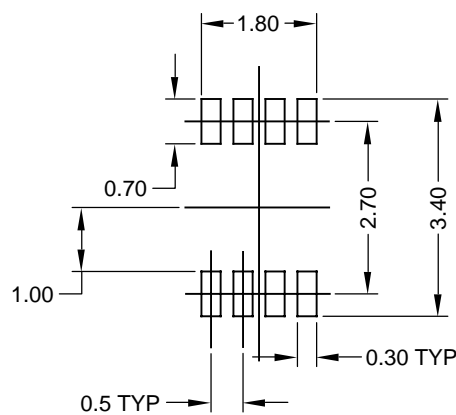
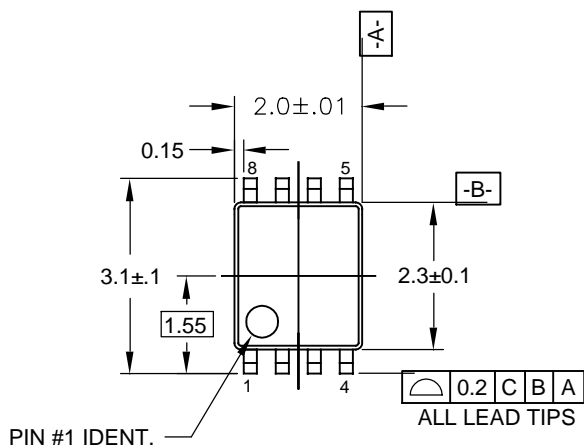
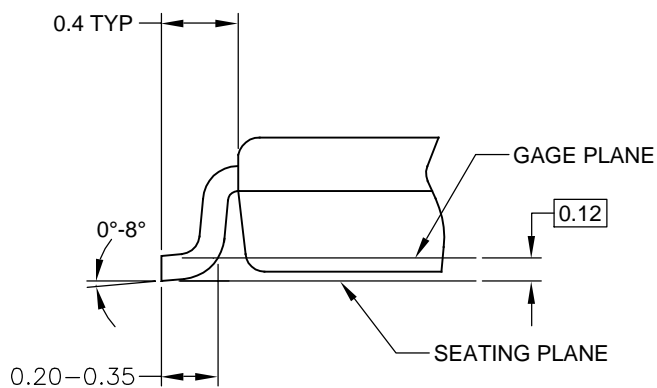
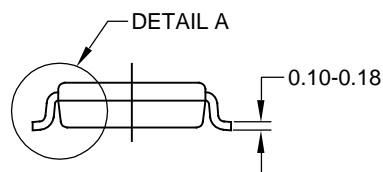
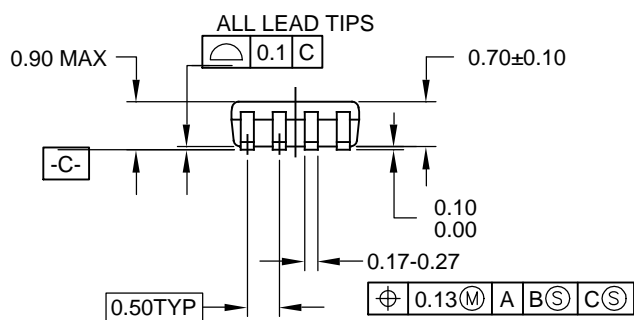


REVISIONS				
LTR	DESCRIPTION	EDCN	DATE	BY/APPD
A	RELEASE TO DOCUMENT CONTROL	59409	2-14-00	FEITAN
B	REVISED DRAWING NAME FOR JEDEC REF. REVISED LAND PATTERN	ECN-MKT-MAB08AREVB	11-8-01	H. ALLEN
C	CORRECTED TITLE DESCRIPTION	ECN-MKT-MAB08AREVC	2-12-02	H. ALLEN



LAND PATTERN RECOMMENDATION



DETAIL A

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

APPROVALS		DATE	FAIRCHILD		
DRAWN	FEITAN	25-5-99	Bayan Lepas, FIZ, SEMICONDUCTOR™ 11900, Penang, Malaysia.		
DFTG. CHK.			8LD, US8, JEDEC MO-187, 3.1MM WIDE		
ENGR. CHK.			MKT-MAB08A		
PROJECTION		SCALE	SIZE	DRAWING NUMBER	REV
		N/A		MKT-MAB08A	C
DO NOT SCALE DRAWING			SHEET 1 of 1		